

## TMP23x 低消費電力、高精度アナログ出力温度センサ

### 1 特長

- サーマスタに対するコスト効率の優れた代替
- 広い温度範囲にわたって厳密な精度を維持
  - $\pm 2.5^{\circ}\text{C}$  (最大値):  $-40^{\circ}\text{C} \sim +150^{\circ}\text{C}$  (TMP235)
  - $\pm 2.5^{\circ}\text{C}$  (最大値):  $-10^{\circ}\text{C} \sim +125^{\circ}\text{C}$  (TMP236)
- 2つの精度レベルで供給
  - A2 レベル:  $\pm 0.5^{\circ}\text{C}$  (標準値)
  - A4 レベル:  $\pm 1^{\circ}\text{C}$  (標準値)
- 正の勾配のセンサ・ゲイン、オフセット (標準値)
  - $10\text{mV}/^{\circ}\text{C}$ ,  $0^{\circ}\text{C}$  で  $500\text{mV}$  (TMP235)
  - $19.5\text{mV}/^{\circ}\text{C}$ ,  $0^{\circ}\text{C}$  で  $400\text{mV}$  (TMP236)
- 広い動作電源電圧範囲
  - $2.3\text{V} \sim 5.5\text{V}$  (TMP235)
  - $3.1\text{V} \sim 5.5\text{V}$  (TMP236)
- 出力の短絡保護
- 低消費電力:  $9\mu\text{A}$  (標準値)
- 最大  $1000\text{pF}$  の負荷を駆動できる強力な出力
- 供給されるパッケージ・オプション
  - 5ピンの SC70 (DCK) 表面実装
  - 3ピンの SOT-23 (DBZ) 表面実装
  - 業界標準の LMT8x-Q1 および LM20 温度センサとフットプリント互換

### 2 アプリケーション

- グリッド・インフラ
- ワイヤレスおよびテレコム・インフラ
- 車載用インフォテインメント
- ファクトリ・オートメーションとファクトリ制御
- 試験 / 測定機器

### 3 概要

TMP23x デバイスは、温度に比例する出力電圧を備えた高精度 CMOS IC リニア・アナログ温度センサのファミリーであり、多様なアナログ温度センシング・アプリケーションで使用できます。これらの温度センサは、市販の類似のピン互換デバイスよりも高精度であり、 $0^{\circ}\text{C} \sim +70^{\circ}\text{C}$  の範囲で  $\pm 0.5^{\circ}\text{C}$  (標準値) の精度を持っています。本シリーズの高い精度は、多くのアナログ温度センシング・アプリケーション向けに設計されたものです。TMP235 デバイスは、 $-40^{\circ}\text{C} \sim +150^{\circ}\text{C}$  の温度範囲と、 $2.3\text{V} \sim 5.5\text{V}$  の電源電圧範囲の全体にわたって、 $10\text{mV}/^{\circ}\text{C}$  の正の出力勾配を提供します。より高ゲインの TMP236 センサは、 $-10^{\circ}\text{C} \sim +125^{\circ}\text{C}$  と、 $3.1\text{V} \sim 5.5\text{V}$  の電源電圧範囲について、 $19.5\text{mV}/^{\circ}\text{C}$  の正の出力勾配を提供します。

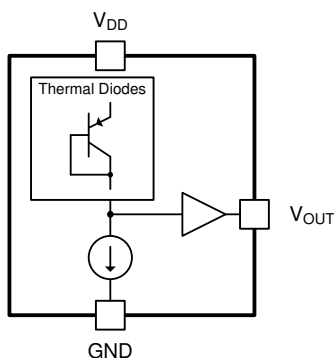
標準静止電流は  $9\mu\text{A}$ 、標準の電源オン時間は  $800\mu\text{s}$  で、効果的な電源サイクリング・アーキテクチャにより、バッテリー駆動のデバイスで消費電力を最小化できます。Class-AB 出力ドライバは最大出力が  $500\mu\text{A}$  と強力で、最大  $1000\text{pF}$  の容量性負荷を駆動でき、アナログ/デジタル・コンバータのサンプルおよびホールド入力と直接接続するよう設計されています。優れた精度と強力なリニア出力ドライバを備えた TMP23x アナログ出力温度センサは、パッシブなサーミスタに代わるコスト効率の優れた代替品となります。

#### 製品情報<sup>(1)</sup>

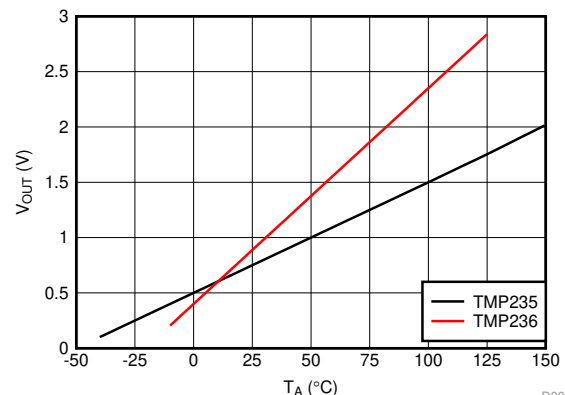
| 型番                | パッケージ      | 本体サイズ (公称)    |
|-------------------|------------|---------------|
| TMP235、<br>TMP236 | SC70 (5)   | 2.00mmx1.25mm |
|                   | SOT-23 (3) | 2.92mmx1.30mm |

(1) 利用可能なすべてのパッケージについては、このデータシートの末尾にある注文情報を参照してください。

機能ブロック図



出力電圧と周囲温度との関係



D003

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## 4 改訂履歴

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

| Revision D (August 2018) から Revision E に変更  | Page |
|---|------|
| • Changed recommended operating temperature range from: $-50^{\circ}\text{C}$ to $150^{\circ}\text{C}$ to: $-40^{\circ}\text{C}$ to $150^{\circ}\text{C}$ | 4    |
| • Changed power supply bypassing recommendations on how to avoid noise effect on the device output  | 12   |

| Revision C (August 2018) から Revision D に変更 | Page |
|--|------|
| • DBZ (SOT-23)パッケージのステータスをプレビュー版から量産データに変更 | 1    |

| Revision B (February 2018) から Revision C に変更   | Page |
|--|------|
| • DBZ (SOT-23)プレビュー版パッケージを追加   | 1    |
| • Added TMP236 test conditions to the operating current parameters   | 5    |
| • Added SOT-23 and SC70 package test conditions to the Accuracy Level 2 (A2) limits in the $0^{\circ}\text{C}$ to $70^{\circ}\text{C}$ range | 5    |

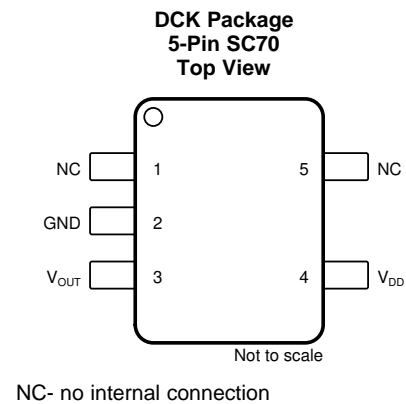
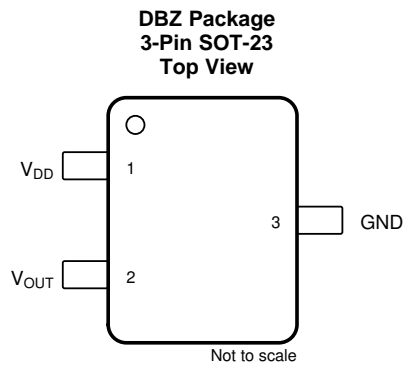
  

| Revision A (December 2017) から Revision B に変更  | Page |
|---|------|
| • 標準精度仕様への言及を、「 $\pm 1^{\circ}\text{C}$ および $\pm 2^{\circ}\text{C}$ 」から「 $\pm 0.5^{\circ}\text{C}$ および $\pm 1^{\circ}\text{C}$ 」へ変更 | 1    |
| • Deleted erroneous AOQL footnote   | 5    |
| • Changed specification limits indicated in <a href="#">図 1</a>   | 6    |
| • Added <i>Device Functional Modes</i> section  | 10   |

| 2017年9月発行のものから更新                  | Page |
|-----------------------------------|------|
| • ドキュメントのステータスを「事前情報」から「量産データ」に変更 | 1    |

## 5 Pin Configuration and Functions



### Pin Functions

| NAME             | PIN    |      | TYPE   | DESCRIPTION  |
|------------------|--------|------|--------|--|
|                  | SOT-23 | SC70 |        |  |
| GND              | 3      | 2    | Ground | Power supply ground.   |
| NC               | —      | 5    | —      | No internal connection. This pin may be left floating or connected to GND. |
| NC               | —      | 1    | —      | No internal connection. This pin may be left floating or connected to GND. |
| V <sub>OUT</sub> | 2      | 3    | O      | Outputs voltage proportional to temperature                                |
| V <sub>DD</sub>  | 1      | 4    | I      | Positive supply input  |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) <sup>(1)</sup>

|                                   | MIN  | MAX                | UNIT |
|-----------------------------------|------|--------------------|------|
| Supply voltage, $V_{DD}$          |      | +6                 | V    |
| Output voltage, $V_{OUT}$         | -0.3 | ( $V_{DD} + 0.3$ ) |      |
| Output current                    | -30  | +30                | mA   |
| Latch-up current, each pin        | -200 | +200               |      |
| Junction temperature ( $T_J$ )    |      | +150               | °C   |
| Storage temperature ( $T_{stg}$ ) | -65  | +150               |      |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

|             |                         |  | VALUE | UNIT |
|-------------|-------------------------|--|-------|------|
| $V_{(ESD)}$ | Electrostatic discharge | Human-body model (HBM) per JESD22-A114 <sup>(1)</sup>                          | ±4000 | V    |
|             |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.  
 (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|          |                                | MIN | NOM | MAX | UNIT |
|----------|--------------------------------|-----|-----|-----|------|
| $V_{DD}$ | Input voltage (TMP235)         | 2.3 |     | 5.5 | V    |
|          | Input voltage (TMP236)         | 3.1 |     | 5.5 |      |
| $T_A$    | Operating free-air temperature | -40 |     | 150 | °C   |

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)(2)</sup> |  | TMP235     |              | UNIT |
|----------------------------------|--|------------|--------------|------|
|                                  |  | DCK (SC70) | DBZ (SOT-23) |      |
|                                  |  | PINS       | PINS         |      |
| $R_{\theta JA}$                  | Junction-to-ambient thermal resistance <sup>(3)(4)</sup> | 275        | 167          | °C/W |
| $R_{\theta JC(top)}$             | Junction-to-case (top) thermal resistance                | 84         | 90           | °C/W |
| $R_{\theta JB}$                  | Junction-to-board thermal resistance                     | 56         | 146          | °C/W |
| $\Psi_{JT}$                      | Junction-to-top characterization parameter               | 1.2        | 35           | °C/W |
| $\Psi_{JB}$                      | Junction-to-board characterization parameter             | 55         | 146          | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.  
 (2) For information on self-heating and thermal response time see [Layout Guidelines](#) section.  
 (3) The junction to ambient thermal resistance ( $R_{\theta JA}$ ) under natural convection is obtained in a simulation on a JEDEC-standard, High-K board as specified in JESD51-7, in an environment described in JESD51-2. Exposed pad packages assume that thermal vias are included in the PCB, per JESD 51-5.  
 (4) Changes in output due to self heating can be computed by multiplying the internal dissipation by the thermal resistance.

## 6.5 Electrical Characteristics

TMP235:  $V_{DD} = 2.3\text{ V to }5.5\text{ V}$ , GND = Ground,  $T_A = -40^\circ\text{C to }+125^\circ\text{C}$  and no load (unless otherwise noted)

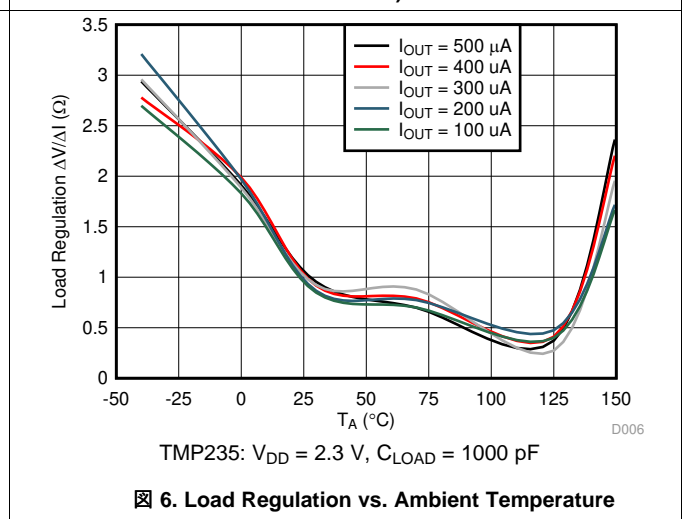
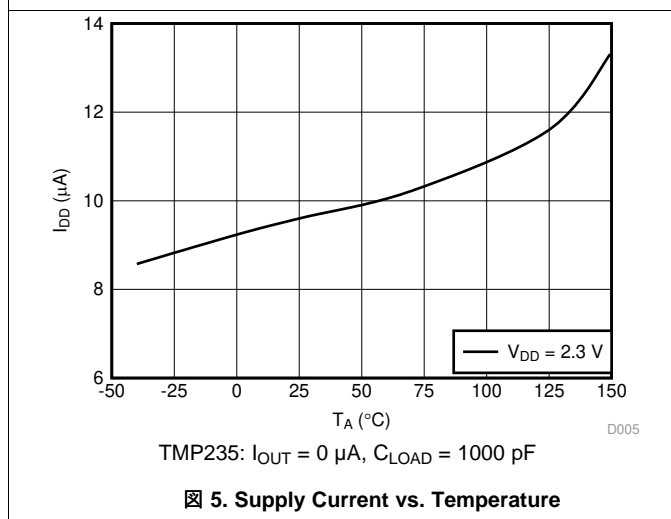
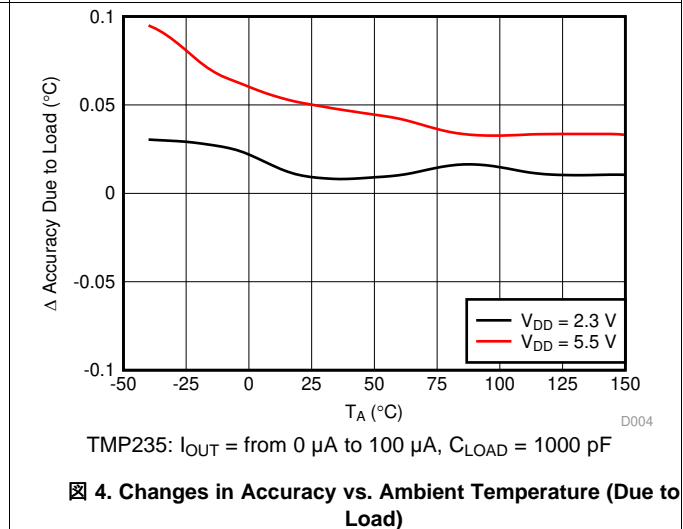
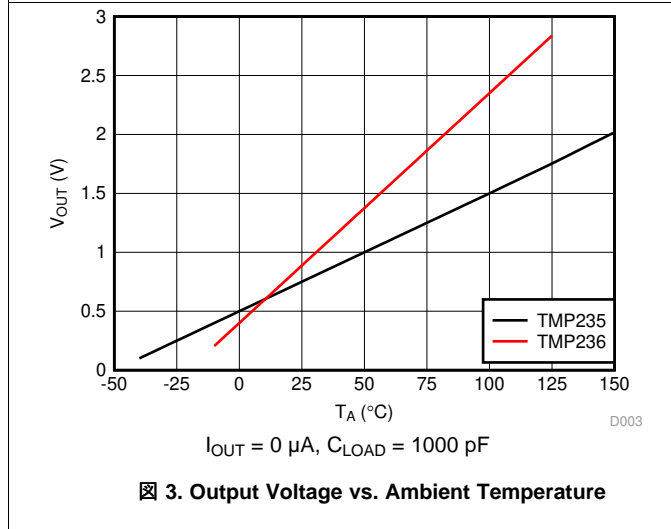
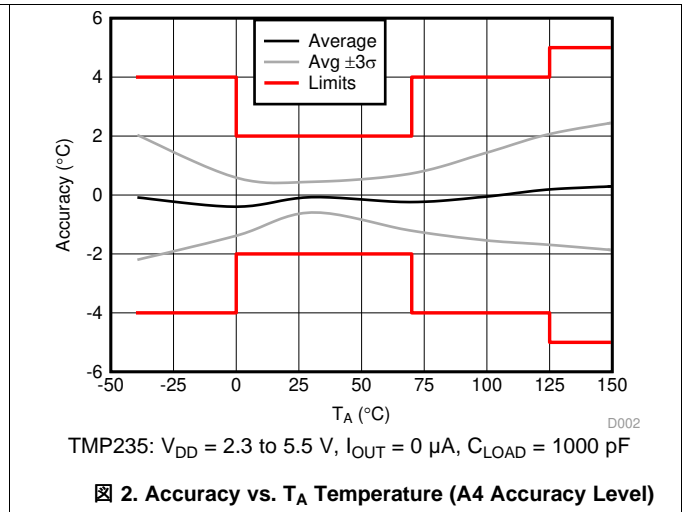
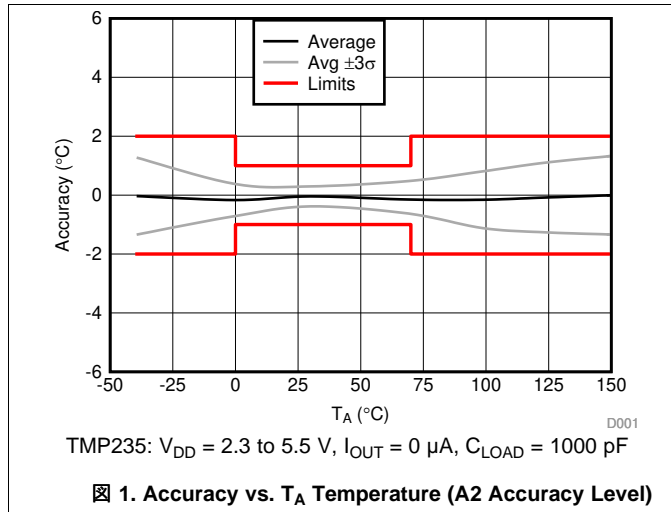
TMP236:  $V_{DD} = 3.1\text{ V to }5.5\text{ V}$ , GND = Ground,  $T_A = -10^\circ\text{C to }+125^\circ\text{C}$  and no load (unless otherwise noted)

| PARAMETER                            |  | TEST CONDITIONS  |   | MIN  | TYP       | MAX  | UNIT                       |
|--------------------------------------|--|--|---|------|-----------|------|----------------------------|
| <b>POWER SUPPLY</b>                  |  |  |   |      |           |      |                            |
| $I_{DD}$                             | Operating current  | $T_A = 25^\circ\text{C}$ , $V_{DD} = 2.3\text{ V}$ , TMP235  |   |      | 9         |      | $\mu\text{A}$              |
|                                      |  | $T_A = 25^\circ\text{C}$ , $V_{DD} = 3.1\text{ V}$ , TMP236  |   |      | 10        |      |                            |
|                                      |  | $T_A = -40^\circ\text{C to }+125^\circ\text{C}$ , TMP235   |   |      |           | 14.5 |                            |
|                                      |  | $T_A = -10^\circ\text{C to }+125^\circ\text{C}$ , TMP236   |   |      |           | 15   |                            |
|                                      |  | $T_A = 150^\circ\text{C}$ , TMP235   |   |      |           | 17   |                            |
| $\Delta^\circ\text{C}/\Delta V_{DD}$ | Line regulation  |  |   | -0.1 | 0.02      | 0.1  | $^\circ\text{C}/\text{V}$  |
| <b>SENSOR ACCURACY</b>               |  |  |   |      |           |      |                            |
| $T_{ACY}$                            | Temperature accuracy <sup>(1)</sup>                        |  | $T_A = 25^\circ\text{C}$                                      |      | $\pm 0.5$ |      | $^\circ\text{C}$           |
|                                      |  |  | $T_A = 0^\circ\text{C to }70^\circ\text{C}$ (SC70 Package)    | -1   | $\pm 0.5$ | +1   |                            |
|                                      |  |  | $T_A = 0^\circ\text{C to }70^\circ\text{C}$ (SOT-23 Package)  | -1.2 | $\pm 0.5$ | +1.2 |                            |
|                                      |  |  | $T_A = -40^\circ\text{C to }+125^\circ\text{C}$ (TMP235A2)    | -2   | $\pm 0.5$ | +2   |                            |
|                                      |  |  | $T_A = -10^\circ\text{C to }+125^\circ\text{C}$ (TMP236A2)    | -2   | $\pm 0.5$ | +2   |                            |
|                                      |  |  | $T_A = -40^\circ\text{C to }+150^\circ\text{C}$ (TMP235A2)    | -2   | $\pm 0.5$ | +2   |                            |
|                                      |  | Accuracy Level 4 (A4)  | $T_A = 25^\circ\text{C}$                                      |      | $\pm 1$   |      |                            |
|                                      |  |  | $T_A = 0^\circ\text{C to }70^\circ\text{C}$                   | -2   | $\pm 1$   | +2   |                            |
|                                      |  |  | $T_A = -40^\circ\text{C to }+125^\circ\text{C}$ (TMP235A4)    | -4   | $\pm 1$   | +4   |                            |
|                                      |  |  | $T_A = -10^\circ\text{C to }+125^\circ\text{C}$ (TMP236A4)    | -4   | $\pm 1$   | +4   |                            |
|                                      | $T_A = -40^\circ\text{C to }+150^\circ\text{C}$ (TMP235A4) | -5   | $\pm 1$   | +5   |           |      |                            |
| <b>SENSOR OUTPUT</b>                 |  |  |   |      |           |      |                            |
| $V_{0^\circ\text{C}}$                | Output voltage offset at $0^\circ\text{C}$                 | TMP235   |   |      | 500       |      | $\text{mV}$                |
|                                      |  | TMP236   |   |      | 400       |      |                            |
| $T_C$                                | Temperature coefficient (sensor gain)                      | TMP235   |   |      | 10        |      | $\text{mV}/^\circ\text{C}$ |
|                                      |  | TMP236   |   |      | 19.5      |      |                            |
| $V_{ONL}$                            | Output nonlinearity <sup>(1)</sup>                         | $T_A = 0^\circ\text{C to }70^\circ\text{C}$ , no load  |   |      | $\pm 0.5$ |      | $^\circ\text{C}$           |
| $I_{OUT}$                            | Output current   |  |   |      |           | 500  | $\mu\text{A}$              |
| $Z_{OUT}$                            | Output impedance   | $I_{OUT} = 100\ \mu\text{A}$ , $f = 100\text{ Hz}$   |   |      | 20        |      | $\Omega$                   |
|                                      |  | $I_{OUT} = 100\ \mu\text{A}$ , $f = 500\text{ Hz}$   |   |      | 50        |      |                            |
|                                      | Output load regulation                                     | $T_A = 0^\circ\text{C to }70^\circ\text{C}$ , $I_{OUT} = 100\ \mu\text{A}$ , $\Delta V_{OUT} / \Delta I_{OUT}$ |   |      | 1         |      | $\Omega$                   |
| $t_{ON}$                             | Turn on time   | Time to reach accuracy within $\pm 0.5^\circ\text{C}$  |   |      | 800       |      | $\mu\text{s}$              |
| $C_{LOAD}$                           | Typical load capacitance                                   |  |   |      |           | 1000 | $\text{pF}$                |
| $t_{RES}$                            | Thermal response to 63%                                    | SC70   | $30^\circ\text{C}$ (Air) to $+125^\circ\text{C}$ (Fluid Bath) |      | 1.3       |      | s                          |

- (1) Accuracy is defined as the error between the measured and reference output voltages, tabulated in the [TMP235 Transfer Table](#) and [TMP236 Transfer Table](#) at the specified conditions of supply voltage and temperature (expressed in  $^\circ\text{C}$ ). Accuracy limits include line regulation within the specified conditions. Accuracy limits do not include load regulation; they assume no DC load.

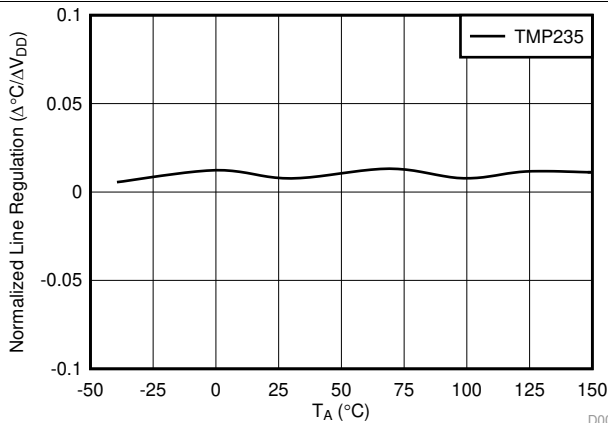
### 6.6 Typical Characteristics

at  $T_A = 25^\circ\text{C}$ , (unless otherwise noted)



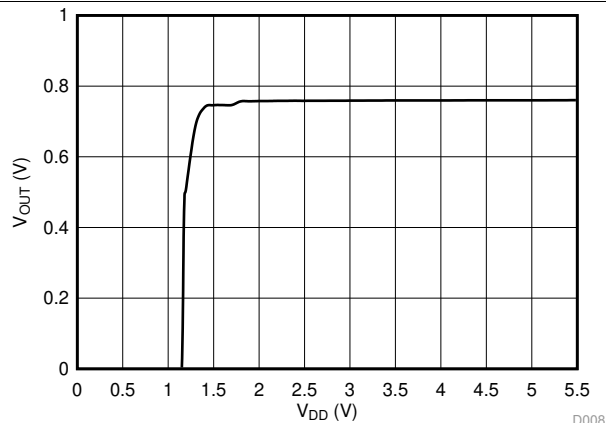
**Typical Characteristics (continued)**

at  $T_A = 25^\circ\text{C}$ , (unless otherwise noted)



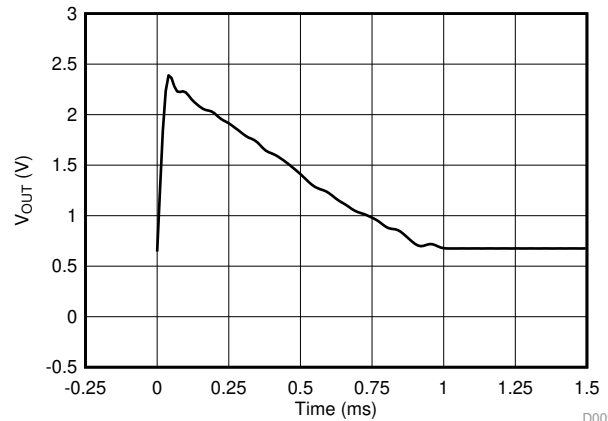
TMP235:  $V_{DD} = 2.3$  to  $5.5$  V,  $I_{OUT} = 0$   $\mu\text{A}$ ,  $C_{LOAD} = 1000$  pF

**Fig 7. Line Regulation ( $\Delta^\circ\text{C} / \Delta V_{DD}$ ) vs. Ambient Temperature**



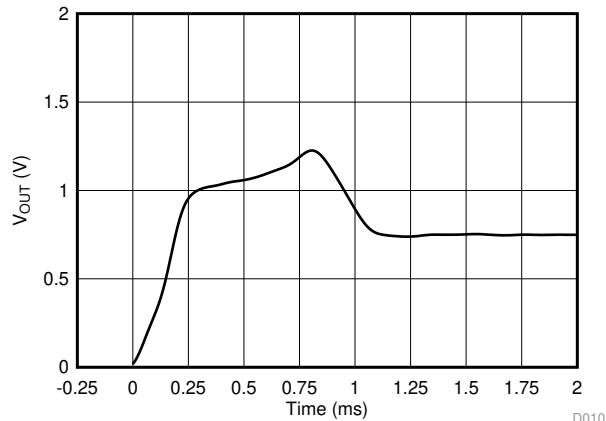
TMP235:  $T_A = 25^\circ\text{C}$

**Fig 8. Output Voltage vs. Power Supply**



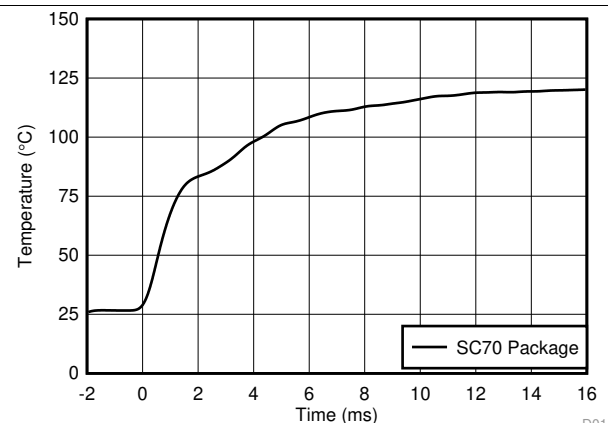
TMP235:  $T_A = 25^\circ\text{C}$

**Fig 9. Output vs. Settling Time to Step  $V_{DD}$**



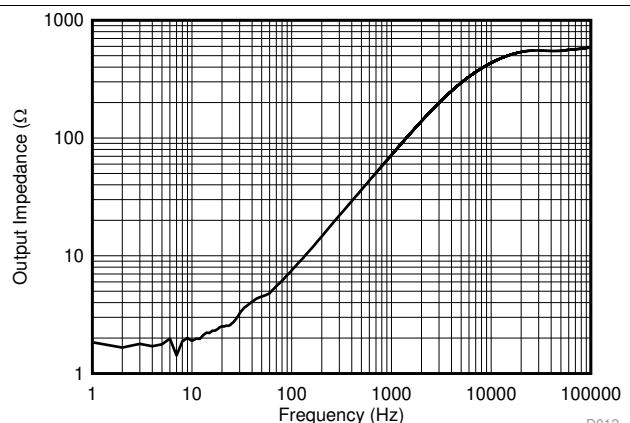
TMP235:  $T_A = 25^\circ\text{C}$ ,  $V_{DD}$  Ramp Rate =  $5$  V/ms

**Fig 10. Output vs. Settling Time to Ramp  $V_{DD}$**



TMP235:  $1 \times 1$  (inches) PCB, Air  $26^\circ\text{C}$  to Fluid Bath  $123^\circ\text{C}$

**Fig 11. Thermal Response (Air-to-Fluid Bath)**



TMP235:  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 5$  V,  $I_{OUT} = 100$   $\mu\text{A}$

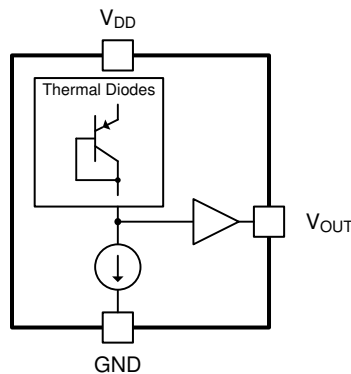
**Fig 12. Output Impedance vs. Frequency**

## 7 Detailed Description

### 7.1 Overview

The TMP23x devices are a family of linear analog temperature sensors with an output voltage proportional to temperature. These temperature sensors have an accuracy from 0°C to 70°C of ±1.25°C (TMP23xA2) and ±2°C (TMP23xA4). The TMP235 device provides a positive slope output of 10 mV/°C over the full –40°C to +150°C temperature range and a supply range from 2.3 V to 5.5 V. The higher gain TMP236 sensor provides a positive slope output of 19.5 mV/°C from –10°C to +125°C and a supply range from 3.1 V to 5.5 V. A class-AB output driver provides a maximum output of 500 µA to drive capacitive loads up to 1000 pF.

### 7.2 Functional Block Diagram



### 7.3 Feature Description

As shown in [Figure 3](#), the TMP23x devices are linear. A small  $V_{OUT}$  gain shift, however, is present at temperatures above 100°C. When small shifts are expected, a piecewise linear function provides the best accuracy and is used for the device accuracy specifications (see [Specifications](#)). Typical output voltages of the TMP23x devices across the full operating temperature range are listed in [Table 3](#) and [Table 4](#). The ideal linear columns represent the ideal linear  $V_{OUT}$  output response with respect to temperature, while the piecewise linear columns indicate the small voltage shift at elevated temperatures.

The piecewise linear function uses three temperature ranges listed in [Table 1](#) and [Table 2](#). In equation form, the voltage output  $V_{OUT}$  of the TMP23x is calculated by [Equation 1](#):

$$V_{OUT} = (T_A - T_{INFL}) \times T_C + V_{OFFS}$$

where

- $V_{OUT}$  is the TMP23x voltage output for a given temperature
- $T_A$  is the ambient temperature in °C
- $T_{INFL}$  is the temperature inflection point for a piecewise segment in °C
- $T_C$  is the TMP23x temperature coefficient or gain
- $V_{OFFS}$  is the TMP23x voltage offset

(1)

Therefore, the  $T_A$  temperature for a given  $V_{OUT}$  voltage output within a piecewise voltage range ( $V_{RANGE}$ ) is calculated in [Equation 2](#). For applications where the accuracy enhancement above 100°C is not required, use the first row of [Table 1](#) and [Table 2](#) for all voltages.

$$T_A = (V_{OUT} - V_{OFFS}) / T_C + T_{INFL}$$

(2)

**表 1. TMP235 Piecewise Linear Function Summary**

| $T_A$ RANGE (°C) | $V_{RANGE}$ (mV) | $T_{INFL}$ (°C) | $T_C$ (mV/°C) | $V_{OFFS}$ (mV) |
|------------------|------------------|-----------------|---------------|-----------------|
| –40 to +100      | < 1500           | 0               | 10            | 500             |
| 100 to 125       | 1500 to 1752.5   | 100             | 10.1          | 1500            |
| 125 to 150       | > 1752.5         | 125             | 10.6          | 1752.5          |



**表 2. TMP236 Piecewise Linear Function Summary**

| $T_A$ RANGE (°C) | $V_{RANGE}$ (mV) | $T_{INFL}$ (°C) | $T_C$ (mV/°C) | $V_{OFFS}$ (mV) |
|------------------|------------------|-----------------|---------------|-----------------|
| –40 to +100      | ≤ 2350           | 0               | 19.5          | 400             |
| 100 to 125       | > 2350           | 100             | 19.7          | 2350            |
| 125 to 150       | —                | —               | —             | —               |

**表 3. TMP235 Transfer Table**

| TEMPERATURE (°C) | $V_{OUT}$ (mV)<br>IDEAL LINEAR VALUES | $V_{OUT}$ (mV)<br>PIECEWISE LINEAR VALUES |
|------------------|---------------------------------------|---|
| –40              | 100                                   | 100                                       |
| –35              | 150                                   | 150                                       |
| –30              | 200                                   | 200                                       |
| –25              | 250                                   | 250                                       |
| –20              | 300                                   | 300                                       |
| –15              | 350                                   | 350                                       |
| –10              | 400                                   | 400                                       |
| –5               | 450                                   | 450                                       |
| 0                | 500                                   | 500                                       |
| 5                | 550                                   | 550                                       |
| 10               | 600                                   | 600                                       |
| 15               | 650                                   | 650                                       |
| 20               | 700                                   | 700                                       |
| 25               | 750                                   | 750                                       |
| 30               | 800                                   | 800                                       |
| 35               | 850                                   | 850                                       |
| 40               | 900                                   | 900                                       |
| 45               | 950                                   | 950                                       |
| 50               | 1000                                  | 1000                                      |
| 55               | 1050                                  | 1050                                      |
| 60               | 1100                                  | 1100                                      |
| 65               | 1150                                  | 1150                                      |
| 70               | 1200                                  | 1200                                      |
| 75               | 1250                                  | 1250                                      |
| 80               | 1300                                  | 1300                                      |
| 85               | 1350                                  | 1350                                      |
| 90               | 1400                                  | 1400                                      |
| 95               | 1450                                  | 1450                                      |
| 100              | 1500                                  | 1500                                      |
| 105              | 1550                                  | 1550.5                                    |
| 110              | 1600                                  | 1601                                      |
| 115              | 1650                                  | 1651.5                                    |
| 120              | 1700                                  | 1702                                      |
| 125              | 1750                                  | 1752.5                                    |
| 130              | 1800                                  | 1805.5                                    |
| 135              | 1850                                  | 1858.5                                    |
| 140              | 1900                                  | 1911.5                                    |
| 145              | 1950                                  | 1964.5                                    |
| 150              | 2000                                  | 2017.5                                    |

**表 4. TMP236 Transfer Table**

| TEMPERATURE (°C) | V <sub>OUT</sub> (mV)<br>IDEAL LINEAR VALUES | V <sub>OUT</sub> (mV)<br>PIECEWISE LINEAR VALUES |
|------------------|--|--|
| -40              | —  | —  |
| -35              | —  | —  |
| -30              | —  | —  |
| -25              | —  | —  |
| -20              | —  | —  |
| -15              | —  | —  |
| -10              | 205  | 205  |
| -5               | 303  | 303  |
| 0                | 400  | 400  |
| 5                | 498  | 498  |
| 10               | 595  | 595  |
| 15               | 693  | 693  |
| 20               | 790  | 790  |
| 25               | 888  | 888  |
| 30               | 985  | 985  |
| 35               | 1083   | 1083   |
| 40               | 1180   | 1180   |
| 45               | 1278   | 1278   |
| 50               | 1375   | 1375   |
| 55               | 1473   | 1473   |
| 60               | 1570   | 1570   |
| 65               | 1668   | 1668   |
| 70               | 1765   | 1765   |
| 75               | 1863   | 1863   |
| 80               | 1960   | 1960   |
| 85               | 2058   | 2058   |
| 90               | 2155   | 2155   |
| 95               | 2253   | 2253   |
| 100              | 2350   | 2350   |
| 105              | 2448   | 2448.5   |
| 110              | 2545   | 2547   |
| 115              | 2643   | 2645.4   |
| 120              | 2740   | 2743.9   |
| 125              | 2838   | 2842.4   |
| 130              | —  | —  |
| 135              | —  | —  |
| 140              | —  | —  |
| 145              | —  | —  |
| 150              | —  | —  |

## 7.4 Device Functional Modes

The singular functional mode of the TMP23x is an analog output directly proportional to temperature.

## 8 Application and Implementation

### NOTE

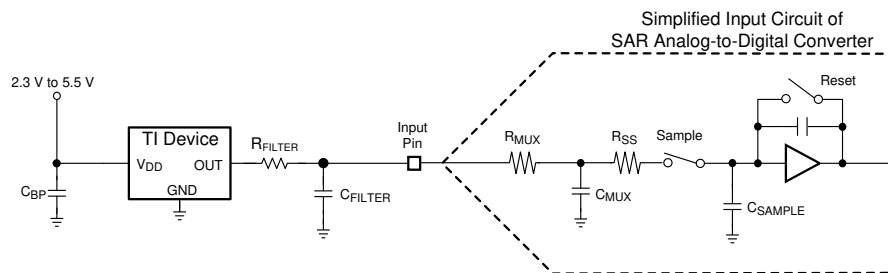
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

The features of the TMP235 make the series of devices designed for various general temperature-sensing applications. The TMP235 and TMP236 devices can operate down to a 2.3-V and a 3.1-V supply with 9- $\mu$ A power consumption, respectively. As a result, the series is designed for battery-powered applications. The TMP23x series is mounted in two surface mount technology packages (SC70 and SOT-23.)

### 8.2 Typical Application

#### 8.2.1 Connection to an ADC



**Figure 13. Suggested Connections to an ADC Input Stage**

##### 8.2.1.1 Design Requirements

See [Figure 13](#) for suggested connections to an ADC input stage. Most CMOS-based ADCs have a sampled data comparator input structure. When the ADC charges the sampling capacitor ( $C_{SAMPLE}$ ), the capacitor requires instantaneous charge from the output of the analog source temperature sensor, such as the TMP23x. Therefore, the output impedance of the temperature sensor can affect ADC performance. In most cases, adding an external capacitor ( $C_{FILTER}$ ) mitigates design challenges. The TMP23x is specified and characterized with a 1000-pF maximum capacitive load ( $C_{LOAD}$ ). [Figure 13](#) shows  $C_{LOAD}$  as the sum of  $C_{FILTER} + C_{MUX} + C_{SAMPLE}$ . TI recommends maximizing the  $C_{FILTER}$  value while allowing for the maximum specified ADC input capacitance ( $C_{MUX} + C_{SAMPLE}$ ) to limit the total  $C_{LOAD}$  at 1000 pF. In most cases, a 680-pF  $C_{FILTER}$  provides a reasonable allowance for ADC input capacitance to minimize ADC sampling error and reduce noise coupling. An optional series resistor ( $R_{FILTER}$ ) and  $C_{FILTER}$  provides additional low-pass filtering to reject system level noise. TI recommends placing  $R_{FILTER}$  and  $C_{FILTER}$  as close as possible to the ADC input for optimal performance.

##### 8.2.1.2 Detailed Design Procedure

Depending on the input characteristics of the ADC, an external  $C_{FILTER}$  may be required. The value of  $C_{FILTER}$  depends on the size of the sampling capacitor ( $C_{SAMPLE}$ ) and the sampling frequency while observing a maximum  $C_{LOAD}$  of 1000 pF. The capacitor requirements can vary because the input stages of all ADCs are not identical. [Figure 13](#) shows a general ADC application as an example only.

## Typical Application (continued)

### 8.2.1.3 Application Curve

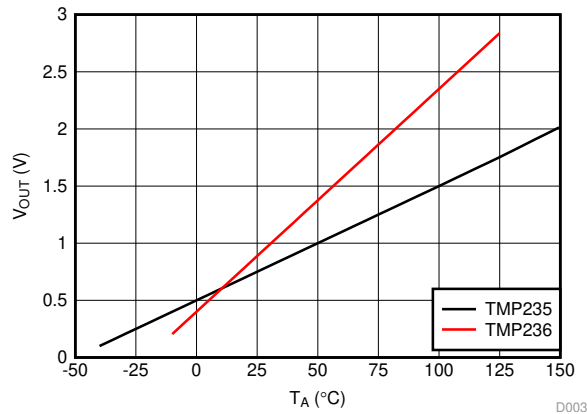


Figure 14. Output Voltage vs. Ambient

## 9 Power Supply Recommendations

The low supply current and supply range of the TMP23x allow the device to be easily powered from many sources.


Power supply bypassing is strongly recommended. In noisy environments, TI recommends to add a filter with 0.1- $\mu$ F capacitor and 100- $\Omega$  resistor between external supply and  $V_{DD}$  to limit the power supply noise. Larger capacitances may be required and are dependent on the noise of the power supply.


## 10 Layout

### 10.1 Layout Guidelines

The layout of the TMP23x series is simple. If a power supply bypass capacitor is used, the capacitor must be connected as [Layout Examples](#) shows.

### 10.2 Layout Examples

 VIA to ground plane

 VIA to power plane

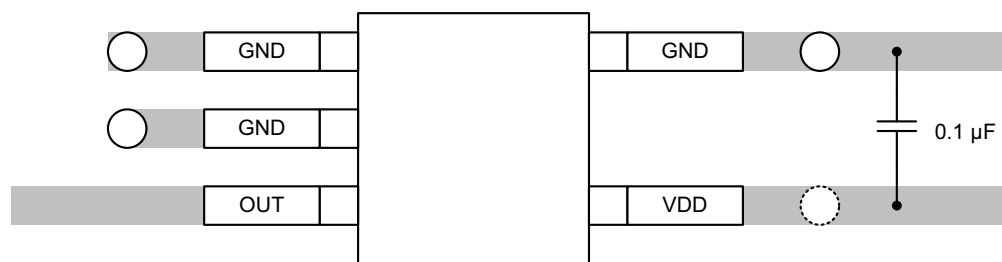


Figure 15. Recommended Layout: SC70 Package

## 11 デバイスおよびドキュメントのサポート

### 11.1 関連リンク

次の表に、クイック・アクセス・リンクを示します。カテゴリには、技術資料、サポートおよびコミュニティ・リソース、ツールとソフトウェア、およびご注文へのクイック・アクセスが含まれます。

表 5. 関連リンク

| 製品     | プロダクト・フォルダ              | ご注文はこちら                 | 技術資料                    | ツールとソフトウェア              | サポートとコミュニティ             |
|--------|-------------------------|-------------------------|-------------------------|-------------------------|-------------------------|
| TMP235 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |
| TMP236 | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> | <a href="#">ここをクリック</a> |

### 11.2 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、[ti.com](http://ti.com)のデバイス製品フォルダを開いてください。右上の「アラートを受け取る」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

### 11.3 コミュニティ・リソース

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 11.4 商標

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### 11.5 静電気放電に関する注意事項



すべての集積回路は、適切なESD保護方法を用いて、取扱いと保存を行うようにして下さい。

静電気放電はわずかな性能の低下から完全なデバイスの故障に至るまで、様々な損傷を与えます。高精度の集積回路は、損傷に対して敏感であり、極めてわずかなパラメータの変化により、デバイスに規定された仕様に適合しなくなる場合があります。

### 11.6 Glossary

**SLYZ022** — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 メカニカル、パッケージ、および注文情報

以降のページには、メカニカル、パッケージ、および注文に関する情報が記載されています。この情報は、そのデバイスについて利用可能な最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TMP235A2DBZR     | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | NIPDAUAG   SN                        | Level-1-260C-UNLIM   | -40 to 150   | 2352                    | <a href="#">Samples</a> |
| TMP235A2DBZT     | OBSOLETE      | SOT-23       | DBZ             | 3    |             | TBD             | Call TI                              | Call TI              | -40 to 150   | 2352                    |                         |
| TMP235A2DCKR     | ACTIVE        | SC70         | DCK             | 5    | 3000        | RoHS & Green    | NIPDAU   SN<br>  NIPDAUAG            | Level-1-260C-UNLIM   | -40 to 150   | 19L                     | <a href="#">Samples</a> |
| TMP235A2DCKT     | OBSOLETE      | SC70         | DCK             | 5    |             | TBD             | Call TI                              | Call TI              | -40 to 150   | 19L                     |                         |
| TMP235A4DBZR     | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | NIPDAUAG   SN                        | Level-1-260C-UNLIM   | -40 to 150   | 2354                    | <a href="#">Samples</a> |
| TMP235A4DBZT     | OBSOLETE      | SOT-23       | DBZ             | 3    |             | TBD             | Call TI                              | Call TI              | -40 to 150   | 2354                    |                         |
| TMP235A4DCKR     | ACTIVE        | SC70         | DCK             | 5    | 3000        | RoHS & Green    | NIPDAU   SN<br>  NIPDAUAG            | Level-1-260C-UNLIM   | -40 to 150   | 19M                     | <a href="#">Samples</a> |
| TMP235A4DCKT     | OBSOLETE      | SC70         | DCK             | 5    |             | TBD             | Call TI                              | Call TI              | -40 to 150   | 19M                     |                         |
| TMP236A2DBZR     | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | NIPDAU   SN<br>  NIPDAUAG            | Level-1-260C-UNLIM   | -10 to 125   | 2362                    | <a href="#">Samples</a> |
| TMP236A2DBZT     | OBSOLETE      | SOT-23       | DBZ             | 3    |             | TBD             | Call TI                              | Call TI              | -10 to 125   | 2362                    |                         |
| TMP236A2DCKR     | ACTIVE        | SC70         | DCK             | 5    | 3000        | RoHS & Green    | NIPDAU   SN<br>  NIPDAUAG            | Level-1-260C-UNLIM   | -10 to 125   | 1BS                     | <a href="#">Samples</a> |
| TMP236A4DBZR     | ACTIVE        | SOT-23       | DBZ             | 3    | 3000        | RoHS & Green    | NIPDAU   SN<br>  NIPDAUAG            | Level-1-260C-UNLIM   | -10 to 125   | 2364                    | <a href="#">Samples</a> |
| TMP236A4DBZT     | OBSOLETE      | SOT-23       | DBZ             | 3    |             | TBD             | Call TI                              | Call TI              | -10 to 125   | 2364                    |                         |
| TMP236A4DCKR     | ACTIVE        | SC70         | DCK             | 5    | 3000        | RoHS & Green    | NIPDAU   SN<br>  NIPDAUAG            | Level-1-260C-UNLIM   | -10 to 125   | 1BT                     | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

- (3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF TMP235, TMP236 :**

- Automotive : [TMP235-Q1](#), [TMP236-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TMP235A2DBZR | SOT-23       | DBZ             | 3    | 3000 | 180.0              | 8.4                | 3.2     | 2.85    | 1.3     | 4.0     | 8.0    | Q3            |
| TMP235A2DCKR | SC70         | DCK             | 5    | 3000 | 180.0              | 8.4                | 2.3     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| TMP235A4DBZR | SOT-23       | DBZ             | 3    | 3000 | 180.0              | 8.4                | 3.2     | 2.85    | 1.3     | 4.0     | 8.0    | Q3            |
| TMP235A4DCKR | SC70         | DCK             | 5    | 3000 | 180.0              | 8.4                | 2.3     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| TMP236A2DBZR | SOT-23       | DBZ             | 3    | 3000 | 180.0              | 8.4                | 3.2     | 2.85    | 1.3     | 4.0     | 8.0    | Q3            |
| TMP236A2DCKR | SC70         | DCK             | 5    | 3000 | 180.0              | 8.4                | 2.3     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |
| TMP236A4DBZR | SOT-23       | DBZ             | 3    | 3000 | 180.0              | 8.4                | 3.2     | 2.85    | 1.3     | 4.0     | 8.0    | Q3            |
| TMP236A4DCKR | SC70         | DCK             | 5    | 3000 | 180.0              | 8.4                | 2.3     | 2.5     | 1.2     | 4.0     | 8.0    | Q3            |



**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TMP235A2DBZR | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| TMP235A2DCKR | SC70         | DCK             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| TMP235A4DBZR | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| TMP235A4DCKR | SC70         | DCK             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| TMP236A2DBZR | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| TMP236A2DCKR | SC70         | DCK             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| TMP236A4DBZR | SOT-23       | DBZ             | 3    | 3000 | 210.0       | 185.0      | 35.0        |
| TMP236A4DCKR | SC70         | DCK             | 5    | 3000 | 210.0       | 185.0      | 35.0        |



# EXAMPLE BOARD LAYOUT

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:18X



SOLDER MASK DETAILS

4214834/E 06/2024

NOTES: (continued)

- 7. Publication IPC-7351 may have alternate designs.
- 8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 THICK STENCIL  
SCALE: 18X

4214834/E 06/2024

NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

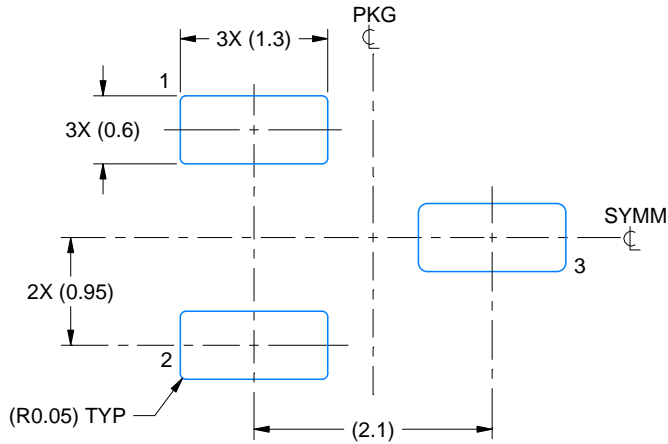


# EXAMPLE BOARD LAYOUT

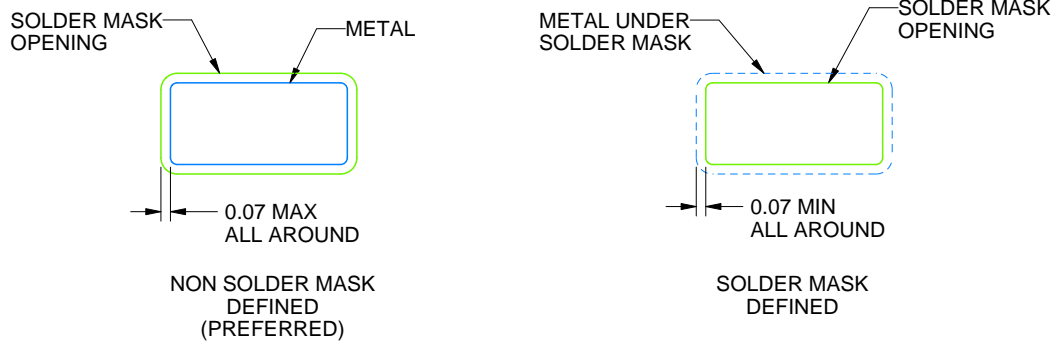
DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
SCALE:15X



SOLDER MASK DETAILS

4214838/E 06/2024

NOTES: (continued)

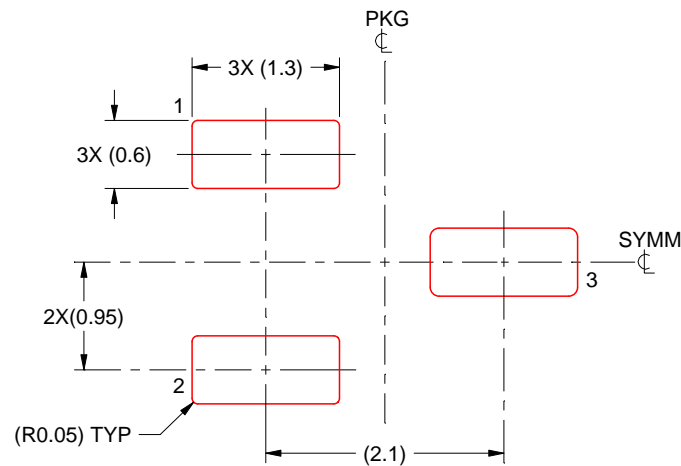
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DBZ0003A

SOT-23 - 1.12 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 THICK STENCIL  
SCALE:15X

4214838/E 06/2024

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

## 重要なお知らせと免責事項

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郵送先住所 : Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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